



NOTES:

1. MATERIALS:
 BASE METAL: HIGH CONDUCTIVE COPPER ALLOY
 PLATING ON CONTACTS: 0.75 MICRON MIN GOLD OVER 1.27 MICRON MIN NICKEL
 PLATING ON BODY: 3.18 MICRON MIN SILVER OVER 1.27 MICRON MIN NICKEL
2. THIS TERMINAL IS DESIGNED TO BE USED WITH HOUSING AND SOLD SEPERATELY.
3. PRODUCT SPECIFICATION: 2155100003-PS
4. APPLICATION SPECIFICATION: 2155101000-AS
5. PACKAGING SPECIFICATION 2046083011-PK.
6. SILVER COMPONENTS WILL BE SUPPLIED TARNISH FREE BUT MAY TARNISH OVER TIME.

BOM								
ASSEMBLY PART NUMBER	1	2	3	QTY	DIM "A"	DIM "B"	DIM "C"	NOTE
	TERMINAL	HOOD	MAIN BODY					
2046083011	204360-0008	204610-1034	204609-3108	1	4.00	6.40	9.15	FOR 8 AWG
2046083012			204609-3109		3.40	5.40		FOR 10 AWG

FUNCTIONAL SYMBOLS $F_A = 0$ $F_C = 0$ $F_D = 0$ DIVISIONAL SYMBOLS	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		CURRENT REV DESC: INITIAL RELEASE			
	DIMENSION UNITS	SCALE	EC NO: 724754			
	mm	10:1	DRWN: CHETAB 2021/07/22			
	GENERAL TOLERANCES (UNLESS SPECIFIED)		CHK'D: GSHARMA 2022/10/20			
ANGULAR TOL ± 0.5°		APPR: HTHYAGARAJ 2022/10/26		PRODUCT CUSTOMER DRAWING		
4 PLACES ±		INITIAL REVISION:		DOCUMENT NUMBER		
3 PLACES ±		DRWN: CHETAB 2021/07/22		2046083011		
2 PLACES ± 0.15		APPR: HTHYAGARAJ 2022/10/26		DOC TYPE DOC PART REVISION		
1 PLACE ± 0.25		DRWN: CHETAB 2021/07/22		PSD 000 A		
0 PLACES ±		APPR: HTHYAGARAJ 2022/10/26		MATERIAL NUMBER CUSTOMER SHEET NUMBER		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIRD ANGLE PROJECTION	DRAWING	SERIES	SERIES MATERIAL NUMBER CUSTOMER SHEET NUMBER	
			D-SIZE	204608	2046083011 GENERAL MARKET 1 OF 1	